

an electronic element mounted on the terminal portions on the upper surface of said substrate, having at least a pair of electrode terminals thereof;

a frame member of insulating resin, bonded on the upper surface of said substrate, and having a cavity formed to store said electronic element therein; and

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a cover member to hermetically seal over the cavity of said frame member, in which said electronic element is stored, wherein electrodes are formed at or in vicinity of positions of the terminals of said electronic element stored within said cavity, to electrically conduct said interior terminal portions for connection to outside said electronic device, wherein said cover member, said frame member and said substrate form a hermetically sealed space in which said electronic element is stored in said cavity without being in direct physical contact with the cover member or the frame member.

Please add new claim 28 as follows:

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28. An electronic device according to claim 21 wherein the electronic element is stored within said cavity without being in direct physical contact with the substrate.
